



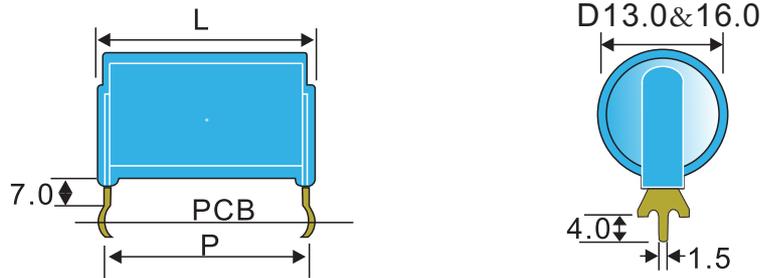
## ● Features

- I High Surge Energy Rating
- II 100% Ceramic Structure.
- III Designed for PCB Withstand.
- IV High Voltage Withstand.
- V Essentially Non-Inductive
- VI Wide Resistivity Range
- VII Coating Approved to U194 V-0.

## ● Reference Standards

JISC 5201-1

## ● Dimensions



For Wr Surge Resistors with Surge Energy Rating 250 J - 650 J:

RESISTOR TYPE	DIM. CODE	OVERALL DIMENSIONS			VOL. V	MAX. J @25°C	MAX. W @25°C	T.T.C. (t)	WT. (g)	A/L (cm)	RESISTANCE RANGE	
		D Max (mm)	L Max (mm)	P ± 1 Pitch (mm)							MIN (Ohms)	MAX (Ohms)
Wr 0250	1111	13	15	12	1.0	250	1.50	165	3.5	0.9	4R7	6K5
Wr 0325	1114	13	18	15	1.3	325	1.80	185	4.0	0.7	10R0	6K9
Wr 0400	1117	13	21	18	1.6	400	2.00	200	5.0	0.6	15R0	9K1
Wr 0550	1414	16	18	15	2.2	550	2.20	245	6.5	1.1	8R0	5K6
Wr 0650	1417	16	21	18	2.6	650	2.50	260	7.0	0.9	10R0	6K3

### NOTES

Vol (v) = Volume of Active Material (cm<sup>3</sup>)

T. T. C. = Thermal Time Constant (t) (Seconds)

## ● Ordering Information

Example:

Wr	2.0	0250	K	4R7
(1)	(2)	(3)	(4)	(5)
Series Name	Power Rating	Joules	Tolerance	Resistace Value

1.Type:Wr SERIES

2.Power:0250=1.50W,0325=1.80W,0400=2.00W,0550=2.20W,0650=2.50W

3.Joules:0250=250,0350=350,0400=400,0550=550,,0650=650

4.Tolerance:K ± 10, M ± 20

5.Resistace Value:MIN:4R7 MAX:9K1

## ● Applications And Ratings

The Maximum Working Voltage levels can be derived from the appropriate formulae illustrated in the tables below. Examples are shown at the foot of this page.

Waveforms are defined in the usual manner: 1.2 / 50  $\mu$ s indicates a rise time to peak value in 1.2  $\mu$ s and an exponential decay to half amplitude in a total time of 50  $\mu$ s.

### Wr 0250

IMPULSE / WAVESHAPe	MAX. WORKING VOLTAGE (kV)
(50 Hz rms)	$1.0 \times (0.9R / t)^{0.3}$
(1.2 / 50 $\mu$ s)	$0.26R \times (-1 + \sqrt{(1 + 69 / R)})$
(10 / 1000 $\mu$ s)	$0.0131R \times (-1 + \sqrt{(1 + 1377 / R)})$
(500 / 5000 $\mu$ s)	$0.0026R \times (-1 + \sqrt{(1 + 6887 / R)})$

### Wr 0325

IMPULSE / WAVESHAPe	MAX. WORKING VOLTAGE (kV)
(50 Hz rms)	$1.3 \times (0.7R / t)^{0.3}$
(1.2 / 50 $\mu$ s)	$0.26R \times (-1 + \sqrt{(1 + 88 / R)})$
(10 / 1000 $\mu$ s)	$0.0131R \times (-1 + \sqrt{(1 + 1753 / R)})$
(500 / 5000 $\mu$ s)	$0.0026R \times (-1 + \sqrt{(1 + 8765 / R)})$

### Wr 0400

IMPULSE / WAVESHAPe	MAX. WORKING VOLTAGE (kV)
(50 Hz rms)	$1.6 \times (0.6R / t)^{0.3}$
(1.2 / 50 $\mu$ s)	$0.26R \times (-1 + \sqrt{(1 + 106 / R)})$
(10 / 1000 $\mu$ s)	$0.0131R \times (-1 + \sqrt{(1 + 2128 / R)})$
(500 / 5000 $\mu$ s)	$0.0026R \times (-1 + \sqrt{(1 + 10644 / R)})$

### Wr 0550

IMPULSE / WAVESHAPe	MAX. WORKING VOLTAGE (kV)
(50 Hz rms)	$1.3 \times (1.1R / t)^{0.3}$
(1.2 / 50 $\mu$ s)	$0.43R \times (-1 + \sqrt{(1 + 54 / R)})$
(10 / 1000 $\mu$ s)	$0.0214R \times (-1 + \sqrt{(1 + 1082 / R)})$
(500 / 5000 $\mu$ s)	$0.0043R \times (-1 + \sqrt{(1 + 5411 / R)})$

### Wr 0650

IMPULSE / WAVESHAPe	MAX. WORKING VOLTAGE (kV)
(50 Hz rms)	$1.6 \times (0.9R / t)^{0.3}$
(1.2 / 50 $\mu$ s)	$0.43R \times (-1 + \sqrt{(1 + 66 / R)})$
(10 / 1000 $\mu$ s)	$0.0214R \times (-1 + \sqrt{(1 + 1314 / R)})$
(500 / 5000 $\mu$ s)	$0.0043R \times (-1 + \sqrt{(1 + 6571 / R)})$

Worked example (50 Hz rms) :

Consider an Wr 0650 Resistor with a Resistance Value of 1K0.

What is the maximum 50 Hz rms Working Voltage (kV) sustainable for an insertion time of 100 ms?

$$V_{\text{working}} = 1.6 \times (0.9R / t) 0.3 = 3.09 \text{ kV}$$

(Note: R = Resistance Value in Ohms and t = 50 Hz Insertion time in ms)

Worked example (10 / 1000 μs) :

Consider an Wr 0650 Resistor with a Resistance Value of 1K0.

What is the maximum Working Voltage (kV) for a 10 / 1000 μs waveform?

$$V_{\text{working}} = 0.0214R \times (-1 + \sqrt{1 + 1314 / R}) = 11.15 \text{ kV}$$

## THERMAL PARAMETERS

Heat generated by Wr Series Resistors is dissipated mainly by radiation and convection from the exposed surface areas. Within restricted domains, mathematical models may be employed to permit heat transfer estimations.

Symbols	$\Delta T$ = Temperature Rise ( $^{\circ}\text{C}$ ) $W_a$ = Watts / Unit Exposed Surface Area ( $\text{W}\cdot\text{cm}^{-2}$ ) $v$ = Volume / Disc ( $\text{cm}^3$ ) $cm$ = Specific Heat Capacity of Active Material = $2\text{J}\cdot\text{cm}^{-3}\cdot^{\circ}\text{C}^{-1}$ $D_o$ = Disc Outside Diameter ( $\text{cm}$ ) $t$ = Resistor Thermal Time Constant ( $\text{s}$ )
Radiation and Convection	$W_a = 0.00026 (\Delta T)^{1.4}$ ( $\Delta T = 50^{\circ}\text{C}$ to $175^{\circ}\text{C}$ , $D_o = 10\text{ mm}$ to $151\text{ mm}$ , Ambient $25^{\circ}\text{C}$ )
Thermal Conductivity	$0.04 \text{ W} / \text{cm}^2 \cdot ^{\circ}\text{C} / \text{cm}$
Maximum Insertion Energy Ratings	For a Resistor initially at $25^{\circ}\text{C}$ : 350 Joules / $\text{cm}^3$ (Infrequently) For a Resistor initially at $25^{\circ}\text{C}$ : 250 Joules / $\text{cm}^3$ (Continuously)
Recommended Operating Temperatures	$200^{\circ}\text{C}$ (Infrequent Operation) $150^{\circ}\text{C}$ (Continuous Operation)
Temperature Rise from Energy Injection	$\Delta T (^{\circ}\text{C}) = \text{Joules (per Resistor)} / (v \times cm)$ (Free Air)
Thermal Time Constant	$t (\text{s}) = \text{Max Joules @ } 25^{\circ}\text{C} / \text{Max Watts @ } 25^{\circ}\text{C}$
Full Cooling	$\geq 4t$
De-rating for other ambient Temperatures ( $T_a$ $^{\circ}\text{C}$ )	Multiply Max Joules @ $25^{\circ}\text{C}$ & Max Watts @ $25^{\circ}\text{C}$ by the ratio $(150 - T_a) / 125$
Repetitive Thermal Impulsing	Assuming that the Heat Transfer Coefficient $\alpha$ ( $\text{W} / \text{cm}^2 \cdot ^{\circ}\text{C} / \text{cm}$ ) is constant over the operating temperature range, then the Peak temperature Rise ( $\Delta T_p$ ) associated with repetitive impulsing can be estimated by way of reference to a classical geometric progression: If $\Delta T_p (^{\circ}\text{C}) = \Delta T \times (1 - (e^{-t/t})^n) / (1 - e^{-t/t})$ ..... 1 Where $\Delta T$ is the Temperature Rise associated with each electrical impulse ( $^{\circ}\text{C}$ ) $t$ is the Resistor Thermal Time Constant ( $\text{s}$ ) $t$ is the Repetition Rate ( $\text{s}$ ) $n$ is the number of impulses If the number of impulses ( $n$ ) $\rightarrow \infty$ (i.e. continuous duty), then equation 1 can be simplified thus: $\Delta T_p (^{\circ}\text{C}) = \Delta T / (1 - e^{-t/t})$ ..... 2

## ● ELECTRICAL PARAMETERS

Resistance Values	E6 and E12 values are available as standard.
Resistance Tolerance	$\pm 20\%$ and $\pm 10\%$ available as standard.
Resistivity Range - $\rho$	10 Ohm cm to 5000 Ohm cm $\rho = R \times A/L$ , where R = Resistance Value
Temperature Coefficient - TCR	-0.05% to -0.15% per °C Temperature Rise depending on Resistivity Value. $TCR = 0.16 \times e^{-(\log \rho / 1.4)} - 0.135$ (% / °C Temperature Rise)
Voltage Coefficient - VCR	-0.5% to -7.5% / kV / cm $VCR = -0.62 \times \rho^{0.22}$ (% / kV / cm) For p domain 10 to 5000 Ohm cm
Inductance	This is negligible (nH) and the Resistors may be described as non-inductive. In practice the inductance of connecting leads will be greater than that of the Resistors.

## ● MECHANICAL PARAMETERS

Explanation of Dimension Code	Each Resistor Type is assigned a 4 digit code, the first 2 digits give the nominal Active Diameter (D) in mm and the last 2 digits give the nominal Active Length (L) of the Resistor in mm. From this information the Volume of Active Material (v) may be determined.
Construction	The Gold Plated Brass terminations are attached to the Copper metallised contact on the Resistor body opposing flat surfaces, with high melting point solder. This permits reliable short time operation at temperatures up to 200 °C
Coating	The UL94 V-0 approved epoxy resin coating is applied by fluidised bed technique. The coating finish is hard, smooth and has good appearance to harmonise with other electronic components. If this range of Resistors experience surface temperatures regularly in excess of 150 °C, the coating will tend to degrade slightly, becoming darker. Though unsightly, performance is not compromised. Whilst the coating can reduce the rate of moisture ingress, it is not impervious to liquids.
Terminations / Soldering	The Gold Plated Brass termination pins are 1.5mm wide by 0.4mm thick with the spring pin format designed to ensure stability during PCB assembly. recommend, as a minimum, PCB mounting holes of 2.0mm Diameter. Soldering is permissible with mildly activated fluxed solders with liquidous properties less than 230 °C.
Coefficient of Linear Expansion	In the range $+4 \times 10^{-6}$ to $+10 \times 10^{-6}$ per °C depending on material Resistivity.